INFORMATION DISCLOSURE STATEMENT BY APPLICANT
Form PTO-1449 (Modified)
(Use several sheets if necessary)

of

COMPLETINE KNOWN				
Application Number	09/018,783			
Confirmation Number	1242			
Filing Date	February 4, 1998			
First Named Inventor	Thomas L. Ritzdorf			
Group Art Unit	2823			
Examiner Name	Deven M. Collins			
Attemey Decket No.	291958182119			

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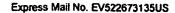
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	COMPLETE IF KNOWN
Application Number	09/018,783
Confirmation Number	1242
Filing Date	February 4, 1998
First Named Inventor	Thomas L. Ritzdorf
Group Art Unit	2811
Examiner Name	Thomas J. Magee
Attorney Docket No.	20105.8162115

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				Application Number	09/018,783-Conf. #1242	
11	IFORMATION	I DI	SCLOSURE	Filing Date	February 4, 1998	
S	TATEMENT I	3Y <i>A</i>	APPLICANT	First Named Inventor	Thomas L. Ritzdorf	
				Art Unit	2811	
	(Use as many sheets as necessary)			Examiner Name	O. Nadav	
Sheet	1	of	1	Attorney Docket Number	291958162US	

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